■ MN101C67G

Туре	MN101C67G (under development)				
ROM (×8-bit)	128 K 10 K TQFP080-P-1212D *Lead-free				
RAM (×8-bit)					
Package					
Minimum Instruction Execution Time	Standard: 0.1 µs (at 2.5 V to 3.6 V, 20 MHz)* 0.2 µs (at 2.1 V to 3.6 V, 10 MHz)* 0.5 µs (at 1.8 V to 3.6 V, 4 MHz)*				
	62.5 μs (at 1.8 V to 3.6 V, 4 MHz)* 62.5 μs (at 1.8 V to 3.6 V, 32 kHz)* Double speed: 0.119 μs (at 2.5 V to 3.6 V, 8.39 MHz)* * The operation guarantee range for flash memory built-in type is 3.0 V to 3.6 V.				
Interrupts	• RESET • Watchdog • External 0 • External 1 • External 2 • External 3 • External 4 • External 5 • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 4 • Timer 5 • Timer 6 • Time base • Serial 0 reception • Serial 0 transmission • Serial 1 reception • Serial 1 transmission • Serial 2 • Serial 3 • Serial 4 • Automatic transfer finish • A/D conversion finish • Timer 7 (2 systems) • Key interrupts (8 lines)				
Timer Counter	Timer counter 0: 8-bit × 1 (square-wave/8-bit PWM output, event count, generation of remote control carrier, pulse width measurement) Clock source				
	Timer counter 1:8-bit × 1 (square-wave output, event count, synchronous output event) Clock source				
	Timer counter 0, 1 can be cascade-connected.				
	Timer counter 2: 8-bit × 1 (square-wave/8-bit PWM output, event count, synchronous output event, pulse width measurement) Clock source				
	Timer counter 3: 8-bit × 1 (square-wave output, event count, generation of remote control carrier) Clock source				
	Timer counter 2, 3 can be cascade-connected.				
	Timer counter 4:8-bit × 1 (square-wave/8-bit PWM output, event count, pulse width measurement, serial 1 baud rate timer) Clock source				
	Interrupt source coincidence with compare register 4				
	Timer counter 5 : 8-bit × 1 (square-wave/8-bit PWM output, event count, pulse width measurement, serial 0 baud rate timer) Clock source				
	Interrupt source ······· coincidence with compare register 5				

	Timer Counter (Continue)		Timer counter 6: 8-bit freerun timer Clock source				
			Timer counter 7: 16-bit × 1 (square-wave/16-bit PWM output, cycle / duty continuous variable, event count, synchronous output evevt, pulse width measurement, input capture) Clock source				
			oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency Interrupt source				
			Watchdog timer Interrupt source				
			DMA controller (automatic data transfer) Max. Transfer cycles ······· 255 Starting factor ······ external request, various types of interrupt, software Transfer mode ······ 1-byte transfer, word transfer, burst transfer				
	Serial Interface		Serial 0 : synchronous type / UART (full-duplex) × 1 Clock source				
			Serial 1 : synchronous type / UART (full-duplex) × 1 Clock source ··················· 1/2, 1/4 of system clock frequency; pulse output of timer counter 4; 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency				
			Serial 2 : synchronous type × 1 Clock source ····································				
			Serial 3 : synchronous type/simple $I^2C \times 1$ Clock source				
			Serial 4: I ² C slave ×1 Applicable for I ² C high-speed transfer mode, 7 bit/10bit address setting, general call				
	I/O Pins	I/O	62 • Common use • Specified pull-up resistor available • Input/output selectable (bit unit)				
		Input	7 • Common use • Specified pull-up resistor available				
	A/D Inputs	D Inputs 10-bit × 7-ch. (with S/H)					
Special Ports Buzzer output, remote control carrier signal output, high-current drive			Buzzer output, remote control carrier signal output, high-current drive port				

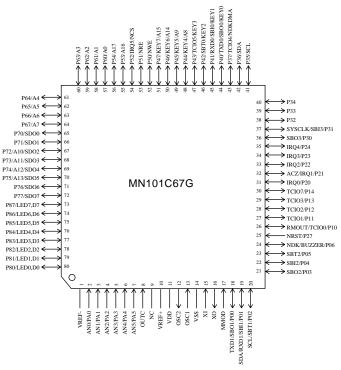
Electrical Characteristics

Supply current

Parameter	Symbol	Condition		Limit		
Parameter	Symbol	Condition		typ	max	Unit
	IDD1	fosc = 20 MHz, VDD = 3 V, (fs = fosc/2)		5	12	mA
Operating supply current	IDD2	fosc = 8.39 MHz, VDD = 3 V, (fs = fosc/2)		2	5	mA
	IDD3	fx = 32.768 kHz, VDD = 3 V, (fs = fx/2)			40	μА
Supply ourrant at HALT	IDD4	fx = 32.768 kHz, VDD = 3 V, Ta = 25°C		4	8	μА
Supply current at HALT	IDD5	fx = 32.768 kHz, VDD = 3 V			30	μА
Cumply augrent at CTOD	IDD6	VDD = 3 V, Ta = 25°C			2	μА
Supply current at STOP	IDD7	VDD = 3 V			20	μА

Ta = -40 °C to +85 °C, VDD = 1.8 V to 3.6 V, VSS = 0 V

Pin Assignment



TQFP080-P-1212D *Lead-free

NC serves as the VPP pin in the MN101CF67G, and cannot be used as a user pin.

Support Tool

In-circuit Emulator	PX-ICE101C / D + PX-PRB101C67-TQFP080-P-1212-M		
Flash Memory Built-in Type	Туре	MN101CF67G [ES (Engineering Sample) available]	
	ROM (× 8-bit)	128 K	
	RAM (× 8-bit)	10 K	
	Minimum instruction execution time	0.1 μs (at 3.0 V to 3.6 V, 20 MHz)	
	Package	TQFP080-P-1212D *Lead-free	

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